

**BSW7221** 

## 5MHz-8000MHz

## **Product Description**

The BSW7221 is a reflective SPDT RF switch that can be used in high power and good performance WLAN 802.11 a/b/g/n/ac/ax, DOCSIS 3.0/3.1 and Wireless Communication applications.

This device is packaged in RoHS2-compliant with 1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN package. It must be used with back side ground soldering.

The BSW7221 has robust ESD protection circuits at all pins and temperature performance (operating temperature range : -40 to +105 °C).

This switch does not require blocking capacitors. If DC is presented at the RF port, add a blocking capacitor. This device also has a high linearity performance over all temperature range such as IIP3, IIP2.

A functional block diagram is shown in Figure 1.

## **Block Diagram**



Figure 1 Functional Block Diagram

## Applications

- WiMAX 802.16
- WLAN 802.11 a/b/g/n/ac/ax
- DOCSIS 3.0/3.1
- Drone
- NFC
- Bluetooth
- Smart Card
- Wireless Infrastructure
- Remote keyless entry
- Telematics / Infotainment
- Two-way radios
- Wireless control systems
- GPS/Navigation

## Package Type



1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN Package Figure 2 Package Type

## **Device Features**

- Output frequency range : 5 MHz to 8.0 GHz
- Fast Switching Time : 90 to 135 ns
- Supply Voltage : 2.7V to 3.6V
- Low insertion loss
- : 0.38dB @ 2.45GHz
- : 0.56dB @ 5.75GHz
- High isolation
  : 44dB @ 2.45GHz
  - : 29dB @ 5.75GHz
- Input 1 dB output compression
  : 37dBm @ 2.45GHz
  - : 35dBm @ 5.75GHz
- High IIP3
  - : 65dBm @ 2.45GHz
  - : 64dBm @ 5.75GHz
- ESD protection (HBM) : 2.0kV @ all pins
- 6-Lead UDFN package : 1.5mm x 1.5mm x 0.5mm
- Operating temperature range : -40°C to +105°C
- Lead-free/RoHS2-compliant UDFN package

•website: <u>www.berex.com</u>



## **Electrical Specifications**

Typical conditions are at VDD = 3.3V,  $T_A = 25$  °C, V1 Low = 0V, V1 High = 3.3V,  $Z_L = 50\Omega$ , Excluding SMA Connector and PCB loss<sup>(1)</sup>, unless otherwise noted.

#### **Table 1 Electrical Specifications**

Parameter	Path	Condition	Min	Тур	Max	Unit
Operating Frequency			5		8000	MHz
		13.56MHz 1GHz		0.28		
Insertion Loss	RFC - RFx	3GHz 4GHz		0.36 0.40 0.41		dB
		5GHz 6GHz 7GHz		0.42 0.64 0.46		
		8GHz		0.40		
		13.56MHz 1GHz 2GHz 3GHz		88 52 47		
Isolation	RFC - RFx	4GHz 5GHz 6GHz		37 35 29		dB
		8GHz		20		
Isolation	RFx - RFx	13.56MHz 1GHz 2GHz 3GHz 4GHz 5GHz 6GHz 7GHz		83 45 36 33 32 30 28 24 21		dB
Return Loss	RFC, RF1, RF2	5MHz – 8GHz (Active port)		20		dB
Input P1dB	RFC - RFx	13.56MHz 2.45GHz 5.75GHz		33 37 35		dBm
Input IP3 <sup>(2)</sup>	RFC - RFx	2.45GHz 5.75GHz		65 64		dBm
Input IP2 <sup>(2)</sup>	RFC - RFx	2.45GHz 5.75GHz		105 90		dBm
2 <sup>nd</sup> Harmonic <sup>(3)</sup>	RFC - RFx	2.45GHz 95 5.75GHz 80			dBc	
3 <sup>rd</sup> Harmonic <sup>(3)</sup>	RFC - RFx	2.45GHz 100 5.75GHz 100			dBc	
Switching Time	RFC - RFx	50% control to 90% RF 50% control to 10% RF		135 90		ns
Settling Time	RFC - RFx	50% CTRL to 0.05dB final value Rising Edge  145    50% CTRL to 0.05dB final value Falling Edge  110			ns	

The typical spurious performance of the BSW7221 is -115dBm / 10Hz @ Over 10MHz

(1) Excluding SMA Connector and PCB loss.

1GHz (0.14dB), 2GHz (0.22dB), 3GHz (0.27dB), 4GHz (0.36dB), 5GHz (0.41dB), 6GHz (0.45dB), 7GHz (0.59dB), 8GHz (0.64dB)

(2) The two-tone Power is 18dBm each and Tone spacing is 20KHz.

(3) Tone Power is 18dBm.

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## **Product Description**



Figure 3 Functional Block Diagram

#### Table 3 V1 Control Truth Table

#### Table 2 Pin Descriptions

No.	Pin Name	Descriptions		
1	V1	Digital Control Logic Input		
2	RFC	RF Common port		
3	VDD	Supply Voltage		
4	RF2	RF2 port		
5	GND	Ground		
6	RF1	RF1 port		
Pad	Exposed Pad	Ground		

V1	RFC-RF1	RFC-RF2
0	OFF	ON
1	ON	OFF

#### **Table 4 Recommended Operation Coditions\***

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage	VDD	2.7	3.3	3.6	V
Supply Current	IDD	-	170	-	μA
Digital Input Control (V1)	V1 High	1.0	-	3.3	V
	V1 Low	0	-	0.7	V
Operating Temperature Range	То	-40	+25	+105	°C
RF Input Power, CW Freq.=2.45GHz, 5.75GHz any port, Ζ <sub>L</sub> =50Ω	-	-	-	30	dBm

\*Specifications are not guaranteed over all recommended operating conditions.

#### **Table 5 Absolute Maximum Ratings**

Parameter		Symbol	Min	Max	Unit	
Supply Voltage		VDD	-0.3	3.6	V	
Digital Input Voltage (V1)		V1	-0.3	3.6	V	
Maximum Input Power, CW (+25°C)		-	-	Input P1dB	dBm	
Storage Temperature range		-	-65	+150	°C	
560	HBM	All pins	-	-	2000	V
ESD	CDM	All pins	-	-	1000	V

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# **BSW7221** 5MHz-8000MHz

## **Typical Performances**

Typical conditions are at VDD = 3.3V,  $T_A = 25^{\circ}$ C, V1 Low = 0V, V1 High = 3.3V,  $Z_L = 50\Omega$ , Excluding SMA Connector and PCB loss, unless otherwise noted.

#### Figure 4 Insertion Loss vs. Vdd (RFC - RFx)



Figure 5 Insertion Loss vs. Temp (RFC - RFx)



Figure 6 Return Loss (RFC, RFx)



Figure 7 Return Loss vs. Temp (RFC)





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## **Typical Performances**

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## Figure 8 Isolation vs. Vdd (RFC - RFx)



## Figure 9 Isolation vs. Temp (RFC - RFx)



Figure 10 Isolation vs. Vdd (RFx - RFx)



Figure 11 Isolation vs. Temp (RFx - RFx)





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## **Evaluation Board**



Figure 12 Evaluation Board Layout





#### Figure 13 Evaluation Board Schematic

RO4003C Er : 3.38	R
	<u> </u>
FR-4 Er : 4.5~4.8	FI
	<u>_</u>
FR-4 Fr : 4.5~4.8	F
	C

COPPER : 1oz (0.035mm), Top Layer	1
RO4003C / 0.2mm	
COPPER : 1oz (0.035mm), Inner 1 Layer	
FR-4 / 0.36mm FINISH THICKNES	S : 1.63T
COPPER : 1oz (0.035mm), Inner 2 Layer	
FR-4 / 0.93mm	
COPPER : 1oz (0.035mm), Bottom Layer	Ļ

No.	Ref Des	Part Qty	Part Number	Remark
1	C1	1	CAP 1005 1uF J 50V	
2	C2,C3*	2	CAP 1005 100pF J 50V	
3	C4	2	CAP 1005 DNI	
4	C5	1	CAP 0603 DNI	
6	J1,J2	2	2 Pin Header	
7	RFC, RF1, RF2	3	SMA_END_LAUNCH	
8	U1	1	BSW7221	

#### Figure 14 Evaluation Board PCB Layer Information

\* C3 should be placed near the device.

## Table 6 Bill of Material - Evaluation Board

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## **Package Outline Drawing**

NOTES :



<u>SIDE VIEW</u>

Dimension and tolerancing conform to ASME Y14.5M-1994.
 Controlling Dimensions : Millimeter. Converted INCH dimension

3. Dimension b applied to Metallized terminal and is measured

between 0.15 to 0.30mm from terminal tip.

are not necessarily exact.



NΥΣ	Common					
B	DIMENSI	ONS MILLI	METER	DIME	ENSIONS IN	NCH
	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
Α	0.45	0.50	0.55	0.018	0.020	0.022
A3	0.1	27 REF	<del>.</del> .	0.0	005 REI	F.
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.20	0.25	0.30	0.008	0.010	0.012
D	1.45	1.50	1.55	0.057	0.059	0.061
D2	1.15	1.20	1.25	0.045	0.047	0.049
E	1.45	1.50	1.55	0.057	0.059	0.061
E2	0.65	0.70	0.75	0.026	0.028	0.030
e	0.500 BSC		0.	050 B2	С	
L	0.125	0.175	0.225	0.005	0.007	0.009
К	0.230	-	-	0.009	-	-

#### Figure 15 Package Outline Drawing



\*Dimensions (mm)

#### Figure 16 Recommended Land Pattern

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## Tape & Reel





## **Package Marking**



	Marking information:						
	Marking Code 1		Marking Code 2				
S	S RF Switch 2 The number of switch throw		The number of switch throw				
2	The number of switch throw	С	Sequential Number				
С	Sequential Number	ХХ	Wafer Lot Number				
Y	Work Year						
ХХ	Wafer Lot Number						

## Figure 18 Package Marking

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## Lead plating finish

#### 100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

## MSL / ESD Rating

ESD information:				
Rating	Class 2 (2000V)			
Test	Human Body Model (HBM)			
Standard	JS-001-2017			

MSL information:				
Rating	Level 1 at +260°C convection reflow			
Standard	JEDEC Standard J-STD-020			



Proper ESD procedures should be followed when handling the device.

## **RoHS Compliance**

This part is compliant with Restrictions on the use of certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

#### NATO CAGE code:



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